RENESAS

BB501M

Built in Biasing Circuit MOS FET IC UHF RF Amplifier

REJ03G0831-0600 (Previous ADE-208-700D) Rev.6.00 Aug.10.2005

Features

- Built in Biasing Circuit; To reduce using parts cost & PC board space.
- High gain;
- PG = 21.5 dB typ. at f = 900 MHz
- Low noise;
- NF = 1.85 dB typ. at f = 900 MHzWithstanding to ESD;
- Built in ESD absorbing diode. Withstand up to 200V at C=200pF, Rs=0 conditions.
- Provide mini mold packages; MPAK-4(SOT-143Rmod)

Outline

RENESAS Package code: PLSP0004ZA-A (Package name: MPAK-4) Notes: 1. Marking is "AS –". 2. BB501M is individual type number of RENESAS BBFET.



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DS}	6	V
Gate1 to source voltage	V _{G1S}	+6	V
		- 0	
Gate2 to source voltage	V _{G2S}	+6	V
		- 0	
Drain current	ID	20	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

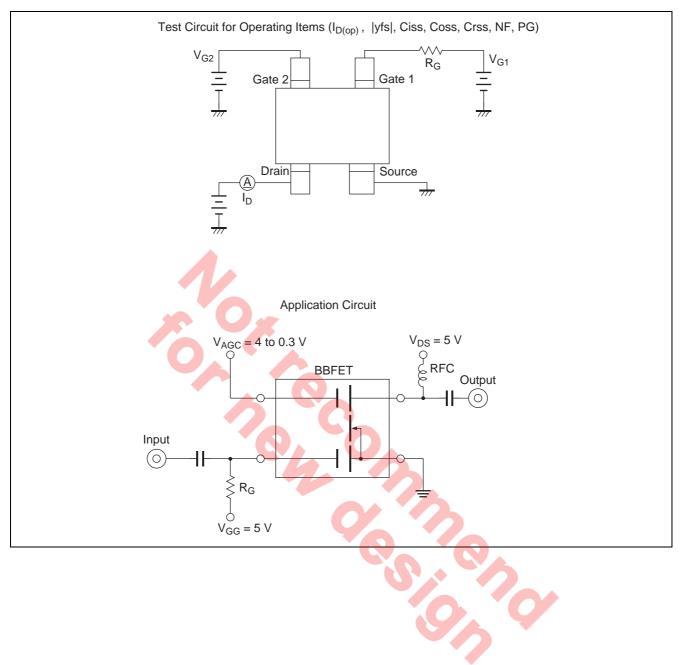
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

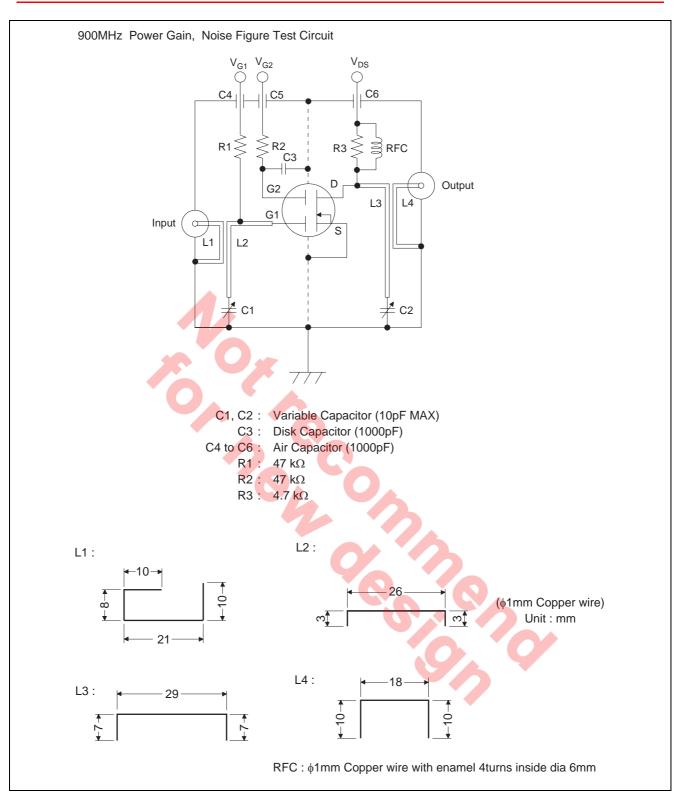
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	6	_		V	$I_D = 200 \ \mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	V _{(BR)G1SS}	+6	—	_	V	I_{G1} = +10 μ A, V_{G2S} = V_{DS} = 0
Gate2 to source breakdown voltage	V _{(BR)G2SS}	+6	—		V	I_{G2} = +10 μ A, V_{G1S} = V_{DS} = 0
Gate1 to source cutoff current	I _{G1SS}		—	+100	nA	V_{G1S} = +5 V, V_{G2S} = V_{DS} = 0
Gate2 to source cutoff current	I _{G2SS}		—	+100	nA	V_{G2S} = +5 V, V_{G1S} = V_{DS} = 0
Gate1 to source cutoff voltage	V _{G1S(off)}	0.5	0.7	1.0	V	V_{DS} = 5 V, V_{G2S} = 4 V
						I _D = 100 μA
Gate2 to source cutoff voltage	V _{G2S(off)}	0.5	0.7	1.0	V	V_{DS} = 5 V, V_{G1S} = 5 V
						I _D = 100 μA
Drain current	I _{D(op)}	7	10	13	mA	V _{DS} = 5 V, V _{G1} = 5 V
						V_{G2S} = 4 V, R_G = 47 k Ω
Forward transfer admittance	y _{fs}	19	24	29	mS	V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} =4 V
						$R_G = 47 \text{ k}\Omega, \text{ f} = 1 \text{ kHz}$
Input capacitance	Ciss	1.4	1.7	2.0	pF	V _{DS} = 5 V, V _{G1} = 5 V
Output capacitance	Coss	0.7	1.1	1.5	pF	V_{G2S} =4 V, R_{G} = 47 k Ω
Reverse transfer capacitance	Crss	_	0.019	0.04	рF	f = 1 MHz
Power gain	PG	17	21.5		dB	V _{DS} = 5 V, V _{G1} = 5 V
Noise figure	NF	_	1.85	2.4	dB	$V_{G2S} = 4 V, R_G = 47 k\Omega$
						f = 900 MHz
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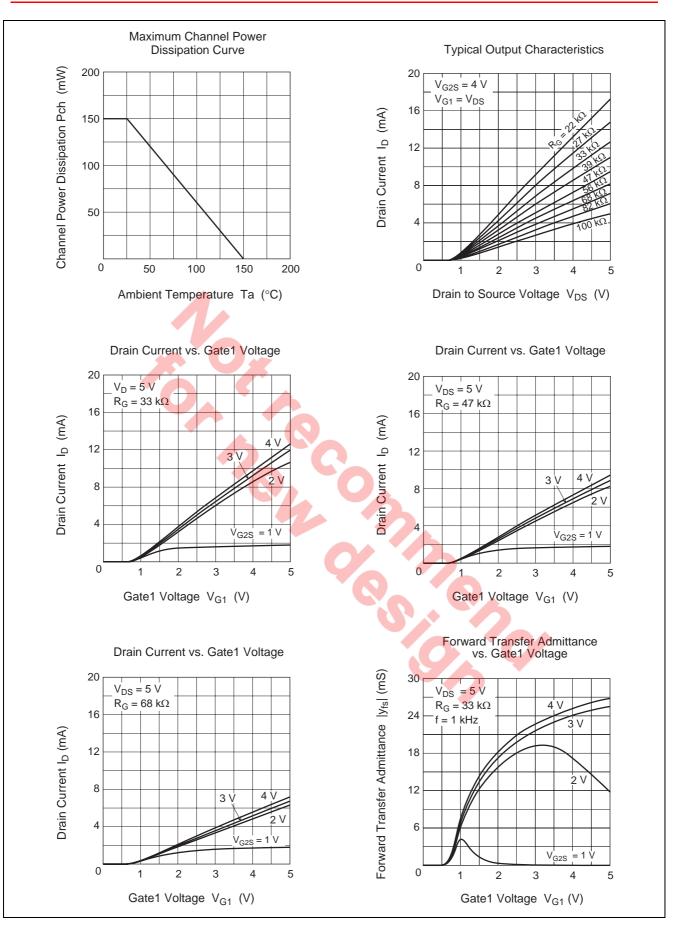
Main Characteristics



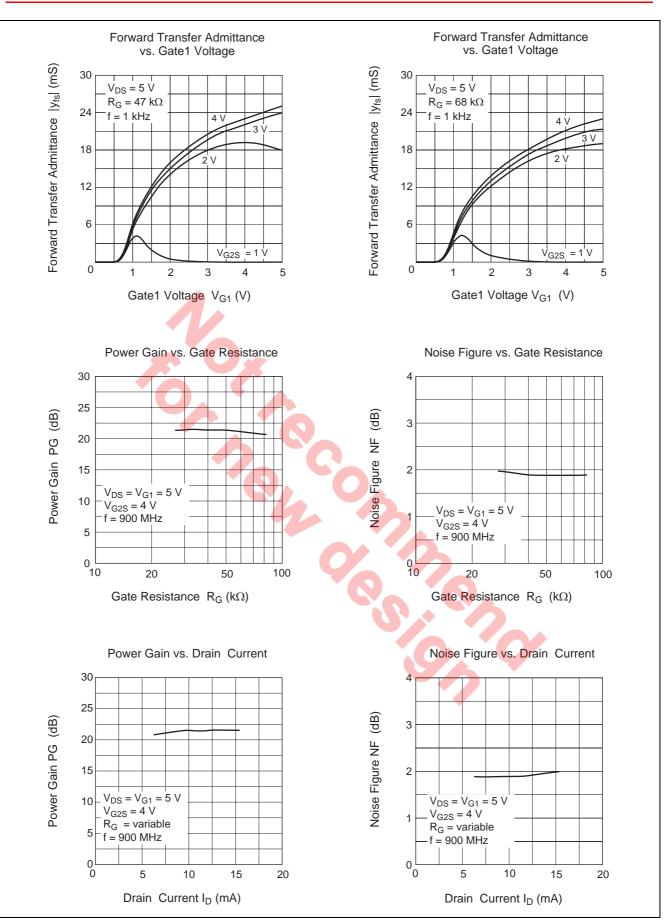




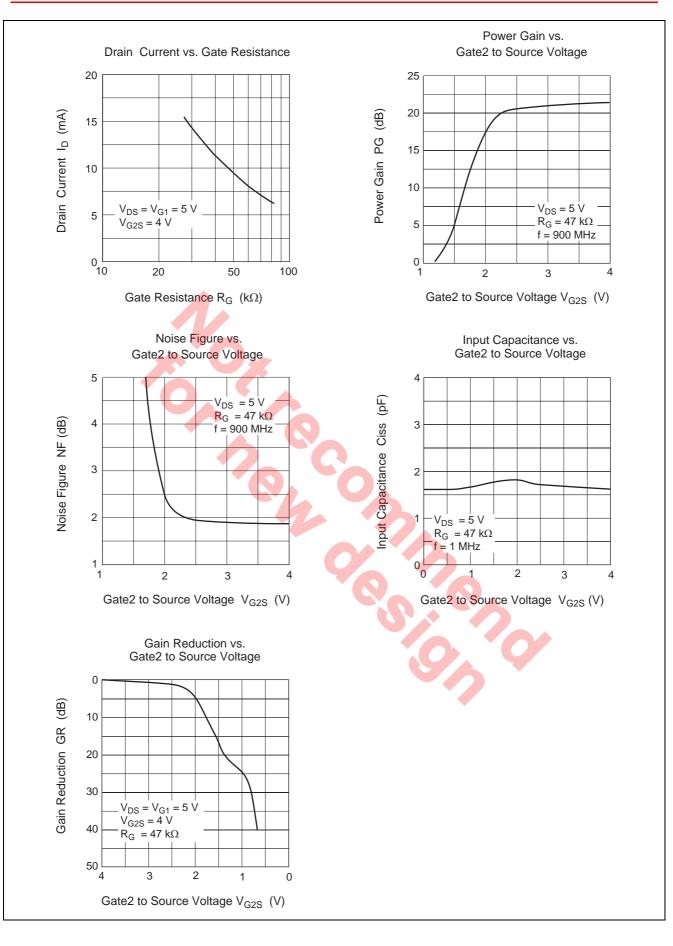




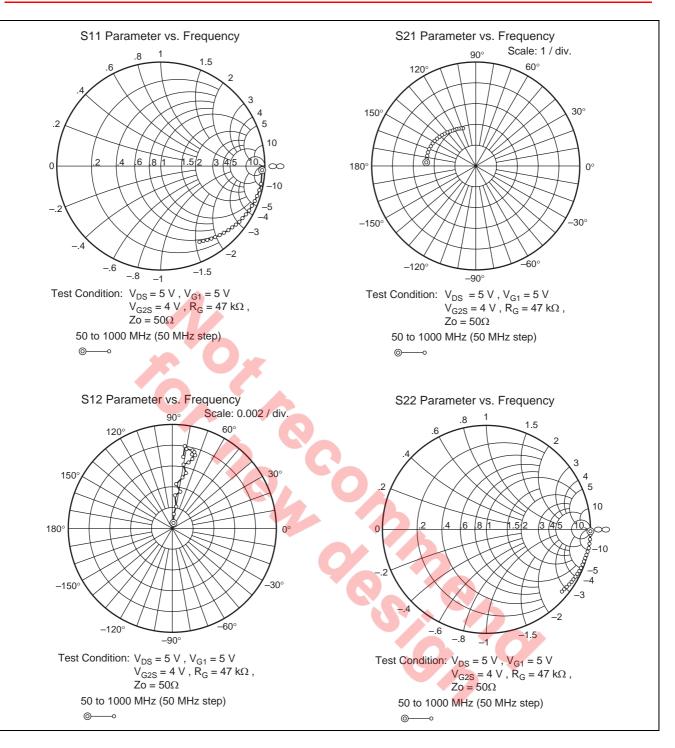














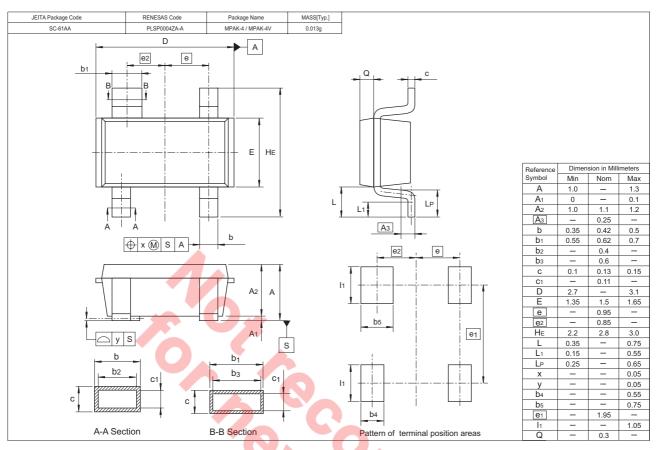
S Parameter

f(MHz)	S11		S21		S12		S22	
1(11112)	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.
50	0.974	-2.8	2.40	176.4	0.00057	78.1	0.997	-2.0
100	0.974	-10.0	2.38	172.2	0.00144	82.4	0.998	-4.2
150	0.974	-13.6	2.38	168.4	0.00211	78.7	0.997	-6.0
200	0.965	-16.5	2.37	164.1	0.00316	84.8	0.995	-8.1
250	0.963	-20.0	2.35	160.4	0.00358	76.3	0.994	-10.2
300	0.953	-23.7	2.32	156.8	0.00431	84.0	0.992	-12.2
350	0.947	-26.8	2.30	152.9	0.00503	79.0	0.990	-14.2
400	0.942	-29.6	2.28	148.6	0.00545	76.6	0.987	-16.2
450	0.929	-32.8	2.26	144.9	0.00630	80.3	0.984	-18.1
500	0.923	-35.4	2.21	141.2	0.00646	76.1	0.981	-20.2
550	0.912	-38.5	2.19	137.6	0.00693	73.7	0.977	-22.1
600	0.903	-41.2	2.15	134.2	0.00732	72.9	0.974	-24.1
650	0.886	-44.2	2.12	130.6	0.00729	74.6	0.971	-26.0
700	0.879	-46.8	2.08	127.4	0.00733	72.0	0.967	-27.8
750	0.873	-49.2	2.06	124.3	0.00762	74.5	0.962	-29.7
800	0.859 🧹	-52.4	2.03	120.8	0.00756	73.7	0.959	-31.7
850	0.846	-55.4	2.00	117.3	0.00772	75.5	0.955	-33.6
900	0.836	-58.0	1.96	114.3	0.00775	79.6	0.951	-35.5
950	0.827	-60.4	1.93	111.0	0.00801	81.7	0.946	-37.3
1000	0.815	-62.8	1.89	108.0	0.00704	81.0	0.942	-39.4





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
BB501MAS-TL-E	3000	

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Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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